Low Voltage Precision Adjustable Shunt Regulator

The TLV431A and B series are precision low voltage shunt regulators that are programmable over a wide voltage range of 1.24 V to 16 V. The TLV431A series features a guaranteed reference accuracy of ±1.0% at 25°C and ±2.0% over the entire industrial temperature range of -40°C to 85°C. For TLV431B series, the accuracy is even higher, it's $\pm 0.5\%$ and $\pm 1.0\%$ respectively. These devices exhibit a sharp low current turn-on characteristic with a low dynamic impedance of 0.20 Ω over an operating current range of 100 μ A to 20 mA. This combination of features makes this series an excellent replacement for zener diodes in numerous applications circuits that require a precise reference voltage. When combined with an optocoupler, the TLV431A/B can be used as an error amplifier for controlling the feedback loop in isolated low output voltage (3.0 V to 3.3 V) switching power supplies. These devices are available in economical TO-92-3 and micro size TSOP-5 and SOT-23-3 packages.

Features

- Programmable Output Voltage Range of 1.24 V to 16 V
- Voltage Reference Tolerance ±1.0% for A Series and ±0.5% for B Series
- Sharp Low Current Turn-On Characteristic
- Low Dynamic Output Impedance of 0.20Ω from $100 \mu A$ to 20 mA
- Wide Operating Current Range of 50 µA to 20 mA
- Micro Miniature TSOP-5, SOT-23-3 and TO-92-3 Packages
- These are Pb-Free and Halide-Free Devices
- SCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable

Applications

- Low Output Voltage (3.0 V to 3.3 V) Switching Power Supply Error Amplifier
- Adjustable Voltage or Current Linear and Switching Power Supplies
- Voltage Monitoring
- Current Source and Sink Circuits
- Analog and Digital Circuits Requiring Precision References
- Low Voltage Zener Diode Replacements

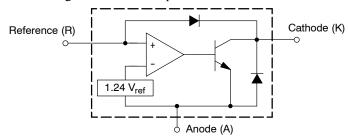
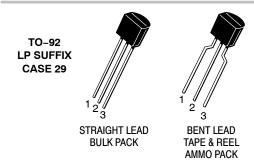


Figure 1. Representative Block Diagram



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TSOP-5 SN SUFFIX CASE 483



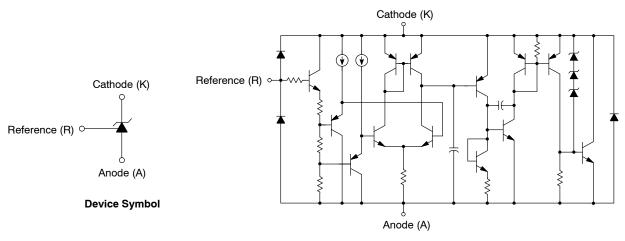
SOT-23-3 SN1 SUFFIX CASE 318

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 12 of this data sheet.

DEVICE MARKING INFORMATION AND PIN CONNECTIONS

See general marking information in the device marking section on page 11 of this data sheet.



The device contains 13 active transistors.

Figure 2. Representative Device Symbol and Schematic Diagram

MAXIMUM RATINGS (Full operating ambient temperature range applies, unless otherwise noted)

Rating	Symbol	Value	Unit
Cathode to Anode Voltage	V _{KA}	18	V
Cathode Current Range, Continuous	I _K	-20 to 25	mA
Reference Input Current Range, Continuous	I _{ref}	-0.05 to 10	mA
Thermal Characteristics LP Suffix Package, TO-92-3 Package Thermal Resistance, Junction-to-Ambient Thermal Resistance, Junction-to-Case SN Suffix Package, TSOP-5 Package Thermal Resistance, Junction-to-Ambient SN1 Suffix Package, SOT-23-3 Package Thermal Resistance, Junction-to-Ambient	R _{eja} R _{ejc} R _{eja} R _{eja}	178 83 226 491	°C/W
Operating Junction Temperature	T _J	150	°C
Operating Ambient Temperature Range	T _A	-40 to 85	°C
Storage Temperature Range	T _{stg}	- 65 to 150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

NOTE: This device series contains ESD protection and exceeds the following tests: Human Body Model 2000 V per MIL–STD–883, Method 3015. Machine Model Method 200 V.

$$P_{D} = \frac{T_{J(max)} - T_{A}}{R_{\theta, JA}}$$

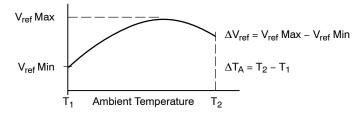
RECOMMENDED OPERATING CONDITIONS

Condition	Symbol	Min	Max	Unit
Cathode to Anode Voltage	V_{KA}	V_{ref}	16	V
Cathode Current	Ι _Κ	0.1	20	mA

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

		TLV431A		TLV431B				
Characteristic	Symbol	Min	Тур	Max	Min	Тур	Max	Unit
Reference Voltage (Figure 3) $(V_{KA} = V_{ref}, I_K = 10 \text{ mA}, T_A = 25^{\circ}\text{C})$ $(T_A = T_{low} \text{ to } T_{high}, \text{ Note 1})$	V _{ref}	1.228 1.215	1.240	1.252 1.265	1.234 1.228	1.240	1.246 1.252	V
Reference Input Voltage Deviation Over Temperature (Figure 3) $(V_{KA} = V_{ref}, I_{K} = 10 \text{ mA}, T_A = T_{low} \text{ to } T_{high}, \text{ Note 1})$	ΔV_{ref}	-	7.2	20	_	7.2	20	mV
Ration of Reference Input Voltage Change to Cathode Voltage Change (Figure 4) $(V_{KA} = V_{ref} \text{ to 16 V, I}_{K} = 10 \text{ mA})$	$\frac{\Delta V_{ref}}{\Delta V_{KA}}$	-	-0.6	-1.5	-	-0.6	-1.5	mV V
Reference Terminal Current (Figure 4) (I _K = 10 mA, R1 = 10 k Ω , R2 = open)	I _{ref}	-	0.15	0.3	-	0.15	0.3	μΑ
Reference Input Current Deviation Over Temperature (Figure 4) (I _K = 10 mA, R1 = 10 k Ω , R2 = open, Notes 1, 2)	ΔI_{ref}	-	0.04	0.08	-	0.04	0.08	μΑ
Minimum Cathode Current for Regulation (Figure 3)	I _{K(min})	-	55	80	_	55	80	μА
Off–State Cathode Current (Figure 5) $ (V_{KA} = 6.0 \text{ V}, V_{ref} = 0) $ $ (V_{KA} = 16 \text{ V}, V_{ref} = 0) $	I _{K(off)}	- -	0.01 0.012	0.04 0.05	- -	0.01 0.012	0.04 0.05	μΑ
Dynamic Impedance (Figure 3) $(V_{KA} = V_{ref}, \ I_K = 0.1 \ \text{mA to } 20 \ \text{mA}, \ f \leq 1.0 \ \text{kHz}, \ \text{Note } 3)$	Z _{KA}	-	0.25	0.4	_	0.25	0.4	Ω

- 1. Ambient temperature range: $T_{low} = -40^{\circ}C$, $T_{high} = 85^{\circ}C$.
- 2. The deviation parameters ΔV_{ref} and ΔI_{ref} are defined as the difference between the maximum value and minimum value obtained over the full operating ambient temperature range that applied.



The average temperature coefficient of the reference input voltage, αV_{ref} is defined as:

$$\alpha V_{ref} \left(\frac{ppm}{^{\circ}C} \right) = \frac{\left(\frac{(\Delta V_{ref})}{V_{ref} \left(T_{A} = 25^{\circ}C \right)} \times 10^{6} \right)}{\Delta T_{A}}$$

 αV_{ref} can be positive or negative depending on whether V_{ref} Min or V_{ref} Max occurs at the lower ambient temperature, refer to Figure 8. Example: $\Delta V_{ref} = 7.2$ mV and the slope is positive,

$$V_{ref}$$
 @ 25°C = 1.241 V ΔT_A = 125°C

$$\alpha V_{ref} \left(\frac{ppm}{^{\circ}C} \right) = \frac{0.0072 \times 10^{6}}{1.241} = 46 \text{ ppm}/^{\circ}C$$

3. The dynamic impedance Z_{KA} is defined as:

$$|Z_{KA}| = \frac{\Delta V_{KA}}{\Delta I_{K}}$$

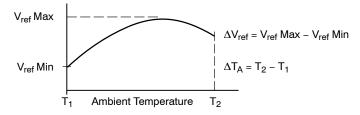
When the device is operating with two external resistors, R1 and R2, (refer to Figure 4) the total dynamic impedance of the circuit is given by:

$$|Z_{KA}'| = |Z_{KA}| \times \left(1 + \frac{R1}{R2}\right)$$

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

	SCV431B		3		
Characteristic	Symbol	Min	Тур	Max	Unit
Reference Voltage (Figure 3) $ (V_{KA} = V_{ref}, I_K = 10 \text{ mA}, T_A = 25^{\circ}\text{C}) $ $ (T_A = -40^{\circ}\text{C to } 85^{\circ}\text{C}) $ $ (T_A = -40^{\circ}\text{C to } 125^{\circ}\text{C}) $	V _{ref}	1.234 1.228 1.224	1.240 - -	1.246 1.252 1.252	V
Reference Input Voltage Deviation Over Temperature (Figure 3) $ (V_{KA} = V_{ref}, I_{K} = 10 \text{ mA}, T_A = -40^{\circ}\text{C to } 85^{\circ}\text{C}) $ $ (V_{KA} = V_{ref}, I_{K} = 10 \text{ mA}, T_A = -40^{\circ}\text{C to } 125^{\circ}\text{C}) $	ΔV_{ref}	-	7.2 7.2	20 24	mV
Ration of Reference Input Voltage Change to Cathode Voltage Change (Figure 4) $(V_{KA} = V_{ref} \text{ to 16 V}, I_{K} = 10 \text{ mA})$	$\frac{\Delta V_{ref}}{\Delta V_{KA}}$	_	-0.6	-1.5	$\frac{mV}{V}$
Reference Terminal Current (Figure 4) ($I_K = 10 \text{ mA}, R1 = 10 \text{ k}\Omega, R2 = \text{open}$)	I _{ref}	-	0.15	0.3	μΑ
Reference Input Current Deviation Over Temperature (Figure 4) (I _K = 10 mA, R1 = 10 k Ω , R2 = open, Notes 4, 5)	ΔI_{ref}	-	0.04	0.08	μΑ
Minimum Cathode Current for Regulation (Figure 3)	I _{K(min})	_	55	80	μΑ
Off–State Cathode Current (Figure 5) $(V_{KA} = 6.0 \text{ V}, V_{ref} = 0)$ $(V_{KA} = 16 \text{ V}, V_{ref} = 0)$	I _{K(off)}	-	0.01 0.012	0.04 0.05	μΑ
Dynamic Impedance (Figure 3) $(V_{KA}=V_{ref},\ I_{K}=0.1\ mA\ to\ 20\ mA,\ f\leq1.0\ kHz,\ Note\ 3)$	Z _{KA}	-	0.25	0.4	Ω

- 4. Ambient temperature range: T_{low} = -40°C, T_{high} = 85°C.
 5. The deviation parameters ΔV_{ref} and ΔI_{ref} are defined as the difference between the maximum value and minimum value obtained over the full operating ambient temperature range that applied.



The average temperature coefficient of the reference input voltage, αV_{ref} is defined as:

$$\alpha V_{ref} \left(\frac{ppm}{^{\circ}C} \right) = \frac{\left(\frac{(\Delta V_{ref})}{V_{ref} (T_{A} = 25^{\circ}C)} \times 10^{6} \right)}{\Delta T_{A}}$$

 αV_{ref} can be positive or negative depending on whether V_{ref} Min or V_{ref} Max occurs at the lower ambient temperature, refer to Figure 8. Example: $\Delta V_{ref} = 7.2 \text{ mV}$ and the slope is positive,

$$V_{ref}$$
 @ 25°C = 1.241 V ΔT_A = 125°C

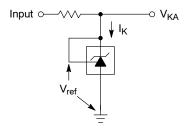
$$\alpha V_{ref} \left(\frac{ppm}{{}^{\circ}C} \right) = \frac{0.0072}{1.241} \times 10^{6} = 46 \text{ ppm}/{}^{\circ}C$$

6. The dynamic impedance $Z_{\mbox{\scriptsize KA}}$ is defined as:

$$|Z_{KA}| = \frac{\Delta V_{KA}}{\Delta I_{K}}$$

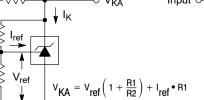
When the device is operating with two external resistors, R1 and R2, (refer to Figure 4) the total dynamic impedance of the circuit is given by:

$$|Z_{KA}'| = |Z_{KA}| \times \left(1 + \frac{R1}{R2}\right)$$



R1

Input ○-

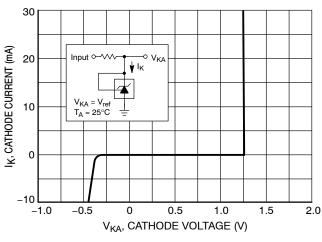


Input O V I_{K(off)} V_{KA}

Figure 3. Test Circuit for $V_{KA} = V_{ref}$

Figure 4. Test Circuit for $V_{KA} > V_{ref}$

Figure 5. Test Circuit for I_{K(off)}



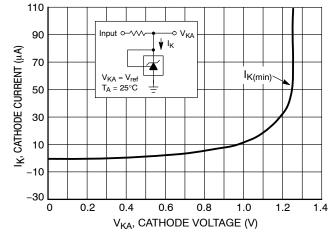


Figure 6. Cathode Current vs. Cathode Voltage

Figure 7. Cathode Current vs. Cathode Voltage

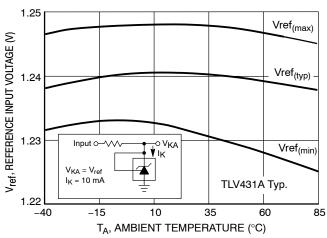


Figure 8. Reference Input Voltage versus Ambient Temperature

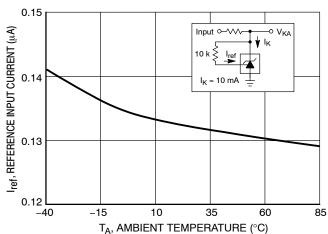
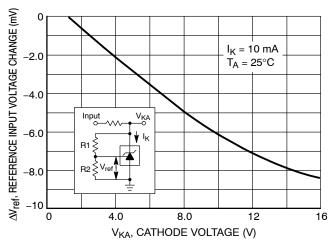


Figure 9. Reference Input Current versus Ambient Temperature

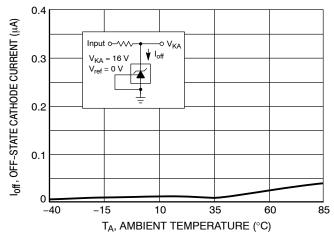


4.0

(Val = 16 V Vref = 0 V Vref

Figure 10. Reference Input Voltage Change versus Cathode Voltage

Figure 11. Off-State Cathode Current versus Cathode Voltage



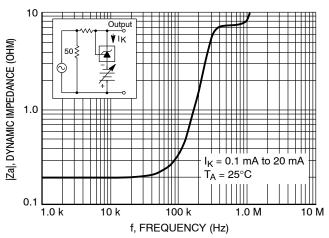
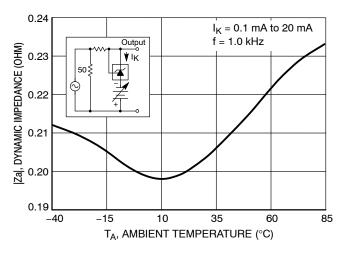


Figure 12. Off-State Cathode Current versus
Ambient Temperature

Figure 13. Dynamic Impedance versus Frequency



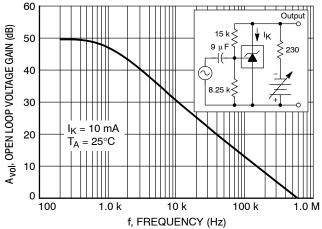
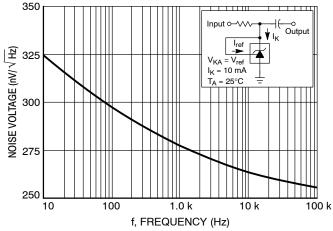


Figure 14. Dynamic Impedance versus

Ambient Temperature

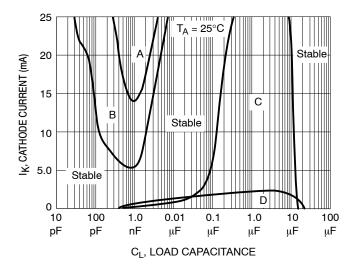
Figure 15. Open–Loop Voltage Gain versus Frequency



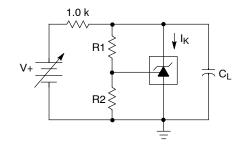
1.8 kΩ Output Generator = 100 kHz 1.5 Output 1.0 (VOLTS) T_A = 25°C 0.5 Input 0 2.0 0 2.0 3.0 5.0 6.0 7.0 8.0 9.0 1.0 4.0 t, TIME (μs)

Figure 16. Spectral Noise Density

Figure 17. Pulse Response







Unstable Regions	V _{KA} (V)	R1 (kΩ)	R2 (kΩ)
A, C	V_{ref}	0	8
B, D	5.0	30.4	10

Figure 19. Test Circuit for Figure 18

Stability

Figures 18 and 19 show the stability boundaries and circuit configurations for the worst case conditions with the load capacitance mounted as close as possible to the device. The required load capacitance for stable operation can vary depending on the operating temperature and capacitor

equivalent series resistance (ESR). Ceramic or tantalum surface mount capacitors are recommended for both temperature and ESR. The application circuit stability should be verified over the anticipated operating current and temperature ranges.

TYPICAL APPLICATIONS

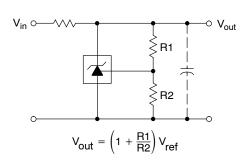


Figure 20. Shunt Regulator

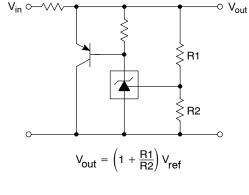


Figure 21. High Current Shunt Regulator

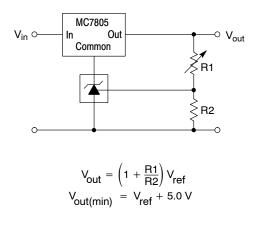


Figure 22. Output Control for a Three Terminal Fixed Regulator

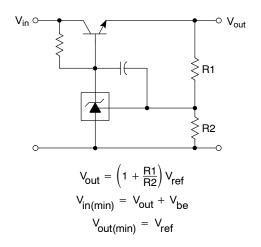


Figure 23. Series Pass Regulator

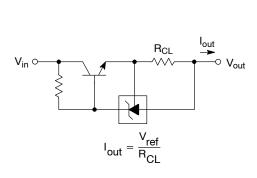


Figure 24. Constant Current Source

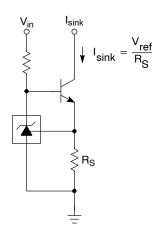


Figure 25. Constant Current Sink

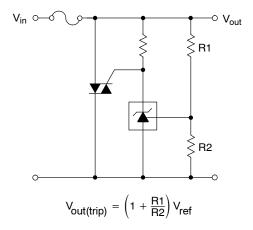


Figure 26. TRIAC Crowbar

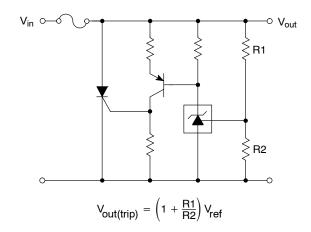
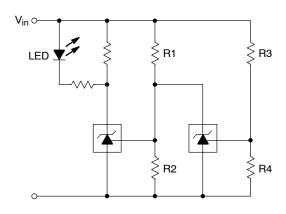


Figure 27. SCR Crowbar



 $\label{eq:L.E.D.} \text{L.E.D. indicator is 'ON' when } V_{in} \text{ is between the upper and lower limits,}$

$$\begin{aligned} & \text{Lower limit} = \left(1 + \frac{R1}{R2}\right) V_{ref} \\ & \text{Upper limit} = \left(1 + \frac{R3}{R4}\right) V_{ref} \end{aligned}$$

Figure 28. Voltage Monitor

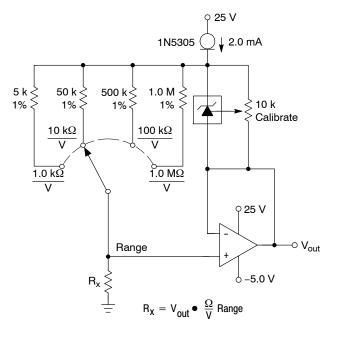


Figure 29. Linear Ohmmeter

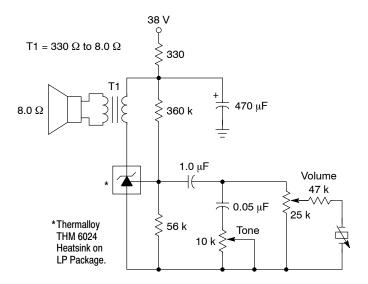


Figure 30. Simple 400 mW Phono Amplifier

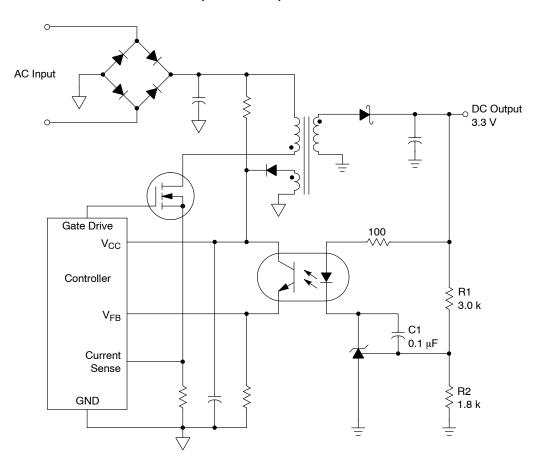
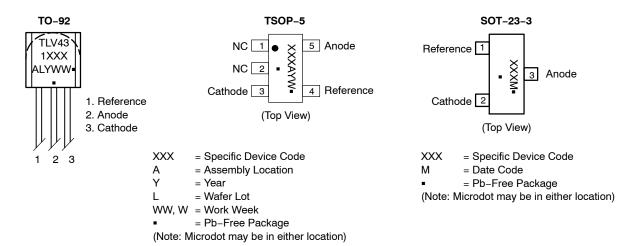


Figure 31. Isolated Output Line Powered Switching Power Supply

The above circuit shows the TLV431A/B as a compensated amplifier controlling the feedback loop of an isolated output line powered switching regulator. The output voltage is programmed to 3.3 V by the resistors values selected for R1 and R2. The minimum output voltage that can be programmed with this circuit is 2.64 V, and is limited by the sum of the reference voltage (1.24 V) and the forward drop of the optocoupler light emitting diode (1.4 V). Capacitor C1 provides loop compensation.

PIN CONNECTIONS AND DEVICE MARKING



ORDERING INFORMATION

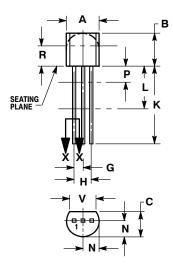
Device	Device Code	Package	Shipping [†]
TLV431ALPG	ALP	TO-92-3 (Pb-Free)	6000/Box
TLV431ALPRAG	ALP	TO-92-3 (Pb-Free)	2000/Tape & Reel
TLV431ALPREG	ALP	TO-92-3 (Pb-Free)	2000/Tape & Reel
TLV431ALPRMG	ALP	TO-92-3 (Pb-Free)	2000/Ammo Pack
TLV431ALPRPG	ALP	TO-92-3 (Pb-Free)	2000/Ammo Pack
TLV431ASNT1G	RAA	TSOP-5 (Pb-Free, Halide-Free)	3000/Tape & Reel
TLV431ASN1T1G	RAF	SOT-23-3 (Pb-Free, Halide-Free)	3000/Tape & Reel
TLV431BLPG	BLP	TO-92-3 (Pb-Free)	6000/Box
TLV431BLPRAG	BLP	TO-92-3 (Pb-Free)	2000/Tape & Reel
TLV431BLPREG	BLP	TO-92-3 (Pb-Free)	2000/Tape & Reel
TLV431BLPRMG	BLP	TO-92-3 (Pb-Free)	2000/Ammo Pack
TLV431BLPRPG	BLP	TO-92-3 2000/Ammo (Pb-Free)	
TLV431BSNT1G	RAH	TSOP-5 3000/Tape & (Pb-Free, Halide-Free)	
TLV431BSN1T1G	RAG	SOT-23-3 3000/Tape & (Pb-Free, Halide-Free)	
SCV431BSN1T1G*	RAC	SOT-23-3 (Pb-Free, Halide-Free)	3000/Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging

Specifications Brochure, BRD8011/D.
*SCV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q100 Qualified and PPAP Capable.

PACKAGE DIMENSIONS

TO-92 (TO-226) **LP SUFFIX** CASE 29-11 **ISSUE AM**

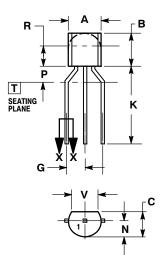


STRAIGHT LEAD **BULK PACK**



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. CONTOUR OF PACKAGE BEYOND DIMENSION R IS UNCONTROLLED.
 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
C	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
H	0.095	0.105	2.42	2.66
7	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
P		0.100		2.54
R	0.115		2.93	
٧	0.135		3.43	



BENT LEAD TAPE & REEL AMMO PACK



- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

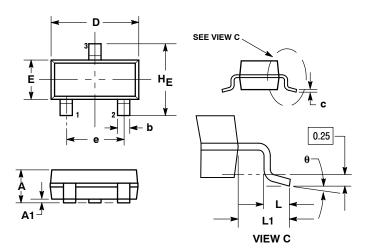
 3. CONTOUR OF PACKAGE BEYOND DIMENSION IS UNCONTROLLED.

 4. LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	MILLIMETERS				
DIM	MIN	MAX			
Α	4.45	5.20			
В	4.32	5.33			
С	3.18	4.19			
D	0.40	0.54			
G	2.40	2.80			
J	0.39	0.50			
K	12.70				
N	2.04	2.66			
Р	1.50	4.00			
R	2.93				
٧	3.43				

PACKAGE DIMENSIONS

SOT-23-3 **SN1 SUFFIX** CASE 318-08 **ISSUE AP**



- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.

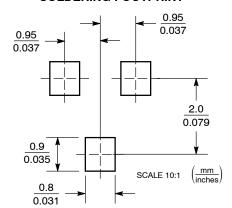
 2. CONTROLLING DIMENSION: INCH.

 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

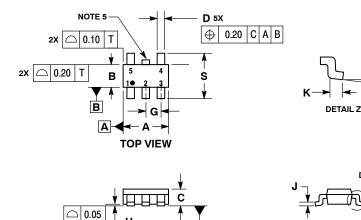
	MILLIMETERS				INCHES	
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.89	1.00	1.11	0.035	0.040	0.044
A1	0.01	0.06	0.10	0.001	0.002	0.004
b	0.37	0.44	0.50	0.015	0.018	0.020
С	0.09	0.13	0.18	0.003	0.005	0.007
D	2.80	2.90	3.04	0.110	0.114	0.120
E	1.20	1.30	1.40	0.047	0.051	0.055
е	1.78	1.90	2.04	0.070	0.075	0.081
L	0.10	0.20	0.30	0.004	0.008	0.012
L1	0.35	0.54	0.69	0.014	0.021	0.029
HE	2.10	2.40	2.64	0.083	0.094	0.104
θ	0°		10°	0°		10°

SOLDERING FOOTPRINT



PACKAGE DIMENSIONS

TSOP-5 **SN SUFFIX** CASE 483-02 ISSUE K



SIDE VIEW

C SEATING PLANE

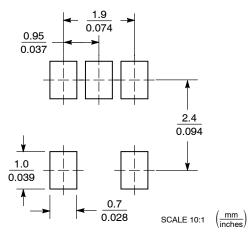
NOTES:

- DIMENSIONING AND TOLERANCING PER ASME
- DIMENSIONING AND TOLERANCING PER ASME
 Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH
 THICKNESS. MINIMUM LEAD THICKNESS IS THE
 MINIMUM THICKNESS OF BASE MATERIAL.
- DIMENSIONS A AND B DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE. DIMENSION A.
- OPTIONAL CONSTRUCTION: AN ADDITIONAL TRIMMED LEAD IS ALLOWED IN THIS LOCATION. TRIMMED LEAD NOT TO EXTEND MORE THAN 0.2 FROM BODY.

	MILLIMETERS				
DIM	MIN	MAX			
Α	3.00	BSC			
В	1.50	BSC			
C	0.90	1.10			
D	0.25	0.50			
G	0.95	BSC			
H	0.01	0.10			
7	0.10	0.26			
K	0.20	0.60			
М	0 °	10°			
S	2.50	3.00			

SOLDERING FOOTPRINT*

END VIEW



DETAIL Z

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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